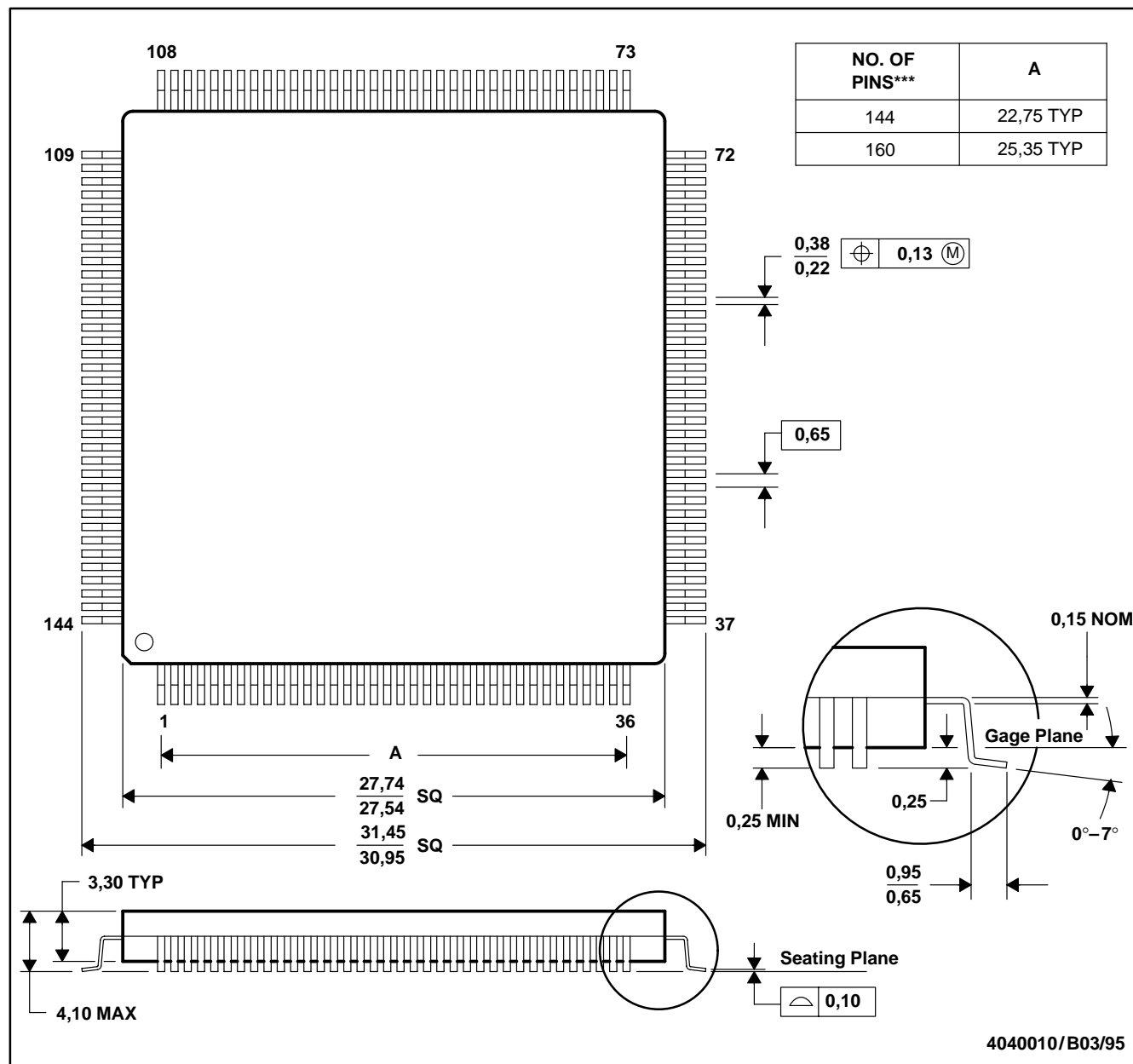


MDN (S-MQFP-G***)

METAL QUAD (MQUAD®) FLATPACK

144 PIN SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - MQUAD is a registered trademark of Olin Corporation.
 - This quad flatpack consists of a circuit mounted on a leadframe and encased within an anodized aluminum shell. The package is intended for parts requiring either a lower stress environment or higher thermal dissipation capabilities than can be supplied by plastic.
 - The 144 MDN is identical to the 160 MDN except four leads per corner are removed.

CAUTION: Ultrasonic cleaning of this package or boards with this package is not permitted.

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